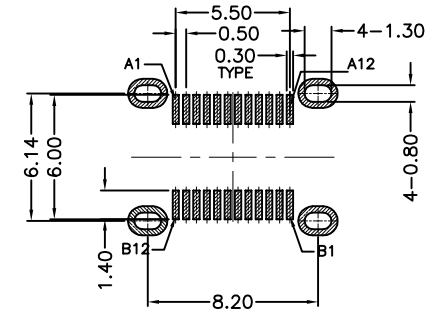
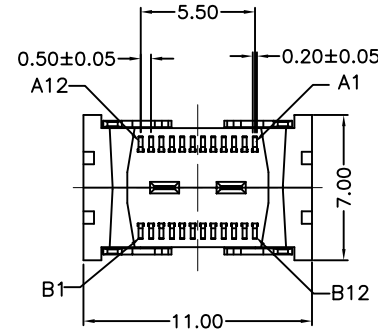
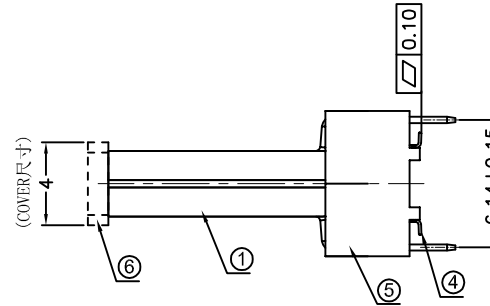
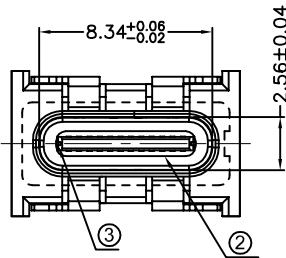
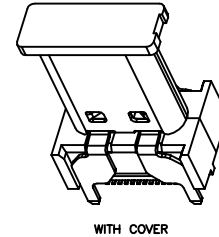
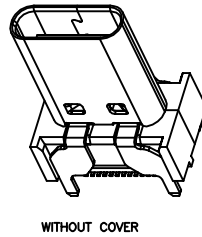
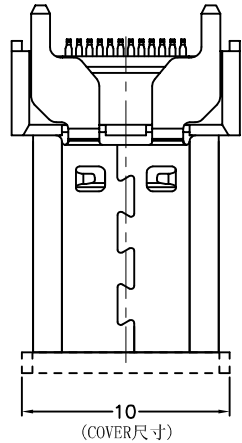


RoHS

REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A0		NEW RELEASE	10/23'20	TXF	/	MOON

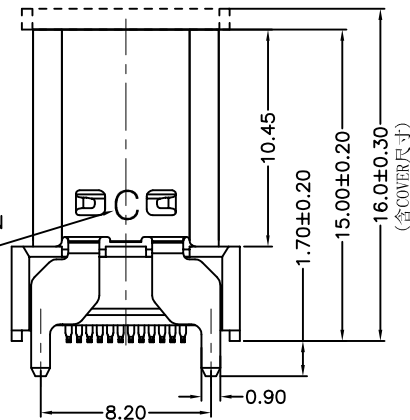
- 1.Contact Resistance:40mOHM Max.;
- 2.Dielectric Withstanding Voltage:100V AC For 1 Minute;
- 3.Insulation Resistance:100M OHM Min.;
- 4.Mating And Unmating Force:
Mating Force: 5~20N
Unmating Force: 8~20N;
6~20N AFTER TEST;
- 5.Durability:10000 Cycles;



RECOMMEND P.C.B LAYOUT(COMPONENT SIDE)

TOLERANCE FOR PCB LAYOUT IS ± 0.05
KEEP OUT AREA

IDENTIFICATION MARK



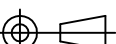
PIN	Signal Name	Description	PIN	Signal Name	Description
A1	GND	Ground return	B12	GND	Ground return
A2	SSTXp1	Positive half of first SuperSpeed TX differential pair	B11	SSRXp1	Positive half of first SuperSpeed RX differential pair
A3	SSTXn1	Negative half of first SuperSpeed TX differential pair	B10	SSRXn1	Negative half of first SuperSpeed RX differential pair
A4	Vbus	Bus Power	B9	Vbus	Bus Power
A5	CC1	Configuration Channel	B8	SR2	Sideband Use (SR)
A6	Dp1	Positive half of the USB 2.0 differential pair-Position 1	B7	Dn2	Negative half of the USB 2.0 differential pair-Position 2
A7	Dn1	Negative half of the USB 2.0 differential pair-Position 1	B6	Dp2	Positive half of the USB 2.0 differential pair-Position 2
A8	SR1	Sideband Use (SR)	B5	CC2	Configuration Channel
A9	Vbus	Bus Power	B4	Vbus	Bus Power
A10	SSRXn2	Negative half of second SuperSpeed RX differential pair	B3	SSTXn2	Negative half of second SuperSpeed TX differential pair
A11	SSRXp2	Positive half of second SuperSpeed RX differential pair	B2	SSTXp2	Positive half of second SuperSpeed TX differential pair
A12	GND	Ground return	B1	GND	Ground return

MILLIMETERS	INCH	UNITS
$X^{\circ} \pm 2^{\circ}$	$X^{\circ} \pm 2^{\circ}$	MM
$.X \pm 0.30$	$.XX \pm 0.012$	MAT'L
$.XX \pm 0.20$	$.XXX \pm 0.008$	SEE NOTES
$.XXX \pm 0.10$	$.XXXX \pm 0.004$	FINISH
		SEE NOTES
		QTY
		SEE NOTES

Item	Title	Material	Dispose	Q'TY
1	Shell	SUS304	Ni:30u" Min.	1PCS
2	GND Plate	SUS301		2PCS
3	Mid Plate	SUS301		1PCS
4	Contact	C7025	Mating Area: See P/N Solder Tails: Matt Tin	2PCS
5	InsertMolding	LCP E6808	UL 94V-0 Black	1PCS
6	COVER	LCP E6808	UL 94V-0 Black	1PCS

XB 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.	
PART NUMBER: XB-104014772	TITLE: TYPE-C 24P 母座 直立式 H=15.0
APPD:	DWG NO.: C-104014772-00
CHKD:	SCALE: 1:1
DR:	SHEET: 1/2
	REV: A0

F

MILLIMETERS	INCH	UNITS MM	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.							
X° ± 2°	X° ± 2°	MAT'L	PART NUMBER: XB-104014772				TITLE: TYPE-C 24P 母座 直立式 H=15.0			
.X ±0.30	.XX ±0.012	SEE NOTES								
.XX ±0.20	.XXX ±0.008	FINISH	APPD:				DWG NO.: C-104014772-00			
.XXX ±0.10	.XXXX±0.004	SEE NOTES	CHKD:							
		QTY	DR:					SCALE	SHEET	REV.
		SEE NOTES						1:1	2/2	A0